

Electronic Patent Application Fee Transmittal

Application Number:	10586908
Filing Date:	24-Jul-2006
Title of Invention:	WIRING DESIGN SUPPORT APPARATUS FOR BOND WIRE OF SEMICONDUCTOR DEVICES
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Attorney Docket Number:	1032404-000154

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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1510	1510
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Total in USD (\$)				1810